

R8C/56E Group

R01AN1288EJ0100 Rev.1.00

I²C bus Single Master Control Program (Master Transmit/Receive) Nov 30, 2012

Abstract

This document describes an I²C bus single master control program (master transmit/receive) using I²C bus interface.

Products

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When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.



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1. Specifications

Transmit and receive data in master mode. The usage conditions are described below. The specifications of this application note conform to the I^2C bus communication protocol.

Usage conditions

- Slave address length: 7 bits
- Transfer rate: Approximately 357 kHz (standard mode and fast mode are supported)
- Single master communication (multi-master is not supported)
- Restart condition generation is not supported

Table 1.1 lists the Peripheral Function and Its Application and Figure 1.1 shows a Block Diagram.

Table 1.1 Peripheral Function and Its Application

Peripheral Function	Application
Clock synchronous serial interface	Transmit and receive data
(I ² C bus interface mode)	



Figure 1.1 Block Diagram



2. Operation Confirmation Conditions

The sample code accompanying this application note has been run and confirmed under the conditions below.

 Table 2.1
 Operation Confirmation Conditions

ltem	Contents	
MCU used	R8C/56E Group	
Operating frequencies	XIN clock: 20 MHz	
	System clock: 20 MHz	
	CPU clock: 20 MHz	
Operating voltage	5.0 V (2.7 to 5.5 V)	
Integrated development Renesas Electronics Corporation		
environment	High-performance Embedded Workshop Version 4.09	
C compiler	Renesas Electronics Corporation	
	M16C Series, R8C Family C Complier V.5.45 Release 01	
	Compile options	
	-D_UART0c -finfo -dir "\$(CONFIGDIR)" -R8C	
	(Default setting is used in the integrated development environment.)	



3. Software

Transmit 3 bytes of data in master transmit mode and then receive 3 bytes of data in master receive mode. Repeat master transmit and master receive alternately.

Settings

- Use the P3_5/SCL pin for the serial clock I/O.
- Use the P3_7/SDA pin for the serial data I/O.
- Set the I²C bus interface mode to master mode.
- Use channel I²C_0.
- Set the transfer clock to f1/56 (set the transfer rate to approximately 357 kHz).
- Select no wait states (data and the acknowledge bit are transferred consecutively) for the wait insertion time.
- Use the MSB first for the transfer format.
- Set SDA digital delay value to $3 \times f1$ cycles.
- Use the receive acknowledge bit (ACKBR bit) to determine an acknowledge signal.
- Use the receive data full interrupt request.
- Use the transmit end interrupt request.
- Use the stop condition detection interrupt request.
- Do not use the transmit data empty interrupt request.
- Do not use the NACK receive interrupt request or arbitration lost/overrun error interrupt request.

Formula for calculating the transfer rate

Transfer rate = Settings for bits CKS3 to CKS0 in the SICR1_0 register

= 20 MHz (f1) ÷ 56 = 357.142 kHz

Notes on using this program

- When using the I²C bus function, access the registers SITDR_0 and SIRDR_0 in 8-bit units.
- In the register definition file which is automatically generated by High-performance Embedded Workshop, data type of the above registers is defined as unsigned short. Therefore, those registers need to be configured as union byte_def or unsigned short in the program.





Figure 3.1 Transfer Format

3.1 Operation Overview

The processing outline is described below. Numbers in parenthesis correspond to the parenthesized numbers in Figures 3.2 to 3.5.

(1) Initial setting

Set the system clock and SFRs associated with I²C bus interface, and initialize the variables used.

(2) Start master control

Generate a start condition. Enable the I^2C bus interface interrupt (transmit end interrupt request) to transmit the slave address.

(3) I^2C bus interface interrupt (transmit end interrupt request)

An interrupt is generated at the rising edge of the ninth bit of the SCL clock.

At master transmit:

• Determine ACK/NACK and set the next byte of transmit data.

At master receive:

- Determine ACK/NACK and set the next byte of transmit data if it is ACK.
- To complete communication, disable the transmit end interrupt request and receive data full interrupt request. Then, generate a stop condition and enable the stop condition detection interrupt request.
- (4) I^2C bus interface interrupt (receive data full interrupt request)

At master receive, an interrupt is generated at the rising edge of the ninth bit of the SCL clock. Set the next byte ACK/NACK and read the receive data. To complete communication, disable the transmit end interrupt request and receive data full interrupt request. Then generate a stop condition and enable the stop condition detection interrupt request.

(5) I^2C bus interface interrupt (stop condition detection interrupt request)

An interrupt is generated when the stop condition is detected. Disable the stop condition detection interrupt request. Read the last receive data at master receive. Set to slave receive mode and disable the I^2C bus interface interrupt.



Figure 3.2 shows an Outline Flowchart and Figure 3.3 to Figure 3.5 show the Timing Diagrams.



Figure 3.2 Outline Flowchart



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Figure 3.3 Operation Timing in Master Transmit Mode



Figure 3.4 Operation Timing in Master Receive Mode (1/2)





Figure 3.5 Operation Timing in Master Receive Mode (2/2)



3.2 Constants

Table 3.1 lists the Constants Used in the Sample Code.

Table 3.1 Constants Used in the Sample Code

Constant Name	Setting Value	Contents
DEVICE_ADDRESS	0b01010101	Slave address (7 bits from b6 to b0 are used)
READ	1	Master receive
WRITE	0	Master transmit
LENGTH	3	Number of transmit/receive data bytes
BUFSIZE	255	Number of transmit/receive data buffers
PD_IIC	0x2E7	Direction register address
PD_IIC_INIT	0b01011111	Direction register setting values
		PD3_5/SCL: input
		PD3_7/SDA: input
IIC_SP_ON	1	Stop condition generated
IIC_SP_OFF	0	Stop condition not generated

3.3 Structure List

Figure 3.6 shows the Structure Used in the Sample Code.

```
typedef union{
                struct{
                                 unsigned char b0:1;
                                 unsigned char bl:1;
                                 unsigned char b2:1;
                                 unsigned char b3:1;
                                 unsigned char b4:1;
                                 unsigned char b5:1;
                                 unsigned char b6:1;
                                 unsigned char b7:1;
                 }bit;
                unsigned char all;
}byte_dt;
Static byte_dtiic_str1;/*-- Device address(b7-b1) + R/W(b0) --*/#define iic_slave_addriic_str1.all/* Slave Address */#define iic_rwiic_str1.bit.b0/* 0: Write (Master Transmit)1: Read (Master Receive) */
Static byte_dtiic_str2;/* -- Status -- */#define iic_statusiic_str2.all/* All status */#define iic_starTiic_str2.bit.b0/* 1: During communication0: Communication end */#define iic_err_pariic_str2.bit.b1/* 1: Parameter error0: not error */#define iic_err_nackiic_str2.bit.b2/* 1: NACK detection error0: not error */#define iic_err_addriic_str2.bit.b3/* 1: Address not match error0: not error */
                                                                                                                                                   0: not error */
static unsigned char iic_length; /* Transfer data length */
static unsigned char iic_index; /* Index of transmit/receiv
static unsigned char far *iic_pointer; /* Pointer of buffer */
                                                                                 /* Index of transmit/receive byte number */
```





3.4 Variables

Table 3.2 lists the Global Variables.

Table 3.2 Global Variables

Туре	Variable Name	Contents	Function Used
unsigned char	iic_tx[BUFSIZE]	Transmit buffer	main
unsigned char	iic_rx[BUFSIZE]	Receive buffer	main

3.5 Functions

Table 3.3 lists the Functions.

Table 3.3 Functions

Function Name	Outline
mcu_init	System clock setting
iic_init	I ² C_0 initial setting
iic_master_start	Master control start processing
_ssuic	I ² C bus interface interrupt processing
stp_int	Stop condition detection processing
master_trn_int	Master transmission
master_rcv_int	Master reception
iic_master_end	Master control end processing



3.6 Function Specifications

The following tables list the sample code function specifications.

main	
Outline	Main processing
Header	iic.h
Declaration	void main(void)
Description	 Perform the following processes. Call the initialization functions for the system clock and I²C bus interface. After the initial setting, master transmission and master reception are repeated alternately. Call the iic_master_start function to start master control and call the iic_master_end function to wait for completion of master control.
Arguments	None
Returned Value	None

mcu_init	
Outline	System clock setting
Header	None
Declaration	void mcu_init(void)
Description	Set the system clock.
Arguments	None
Returned Value	None

iic_init			
Outline	I ² C_0 initial setting		
Header	None		
Declaration	void iic_init(unsigned char ini)		
Description	Perform initial setting for I ² C_0.		
Arguments	unsigned char ini	0: I ² C_0 module disabled	
		1: I ² C_0 module enabled	
Returned Value	None		



iic_master_start			
Outline	Master control start processing		
Header	None		
Declaration	unsigned char iic_master_start(
	unsigned char addr,		
	unsigned char rw,		
	unsigned char far *buf,		
	unsigned char len)		
Description	Perform processing to start mast	er control. Prior to executing this function, execute	
	the lic_init function to enable the	I ² C_0 module.	
	Perform the following processes:		
	 In the function header, all st 	atuses are initialized and the argument parameters	
	are read. If any parameter v	alue is invalid, the parameter error flag is set to 1	
	narameter error is detected	er control start processing is not performed when a	
	 Next, read the bus status. W 	/hen the bus is busy, the returned value is 0 and	
	master control start process	ing is not performed. When the bus is free, the	
	returned value is 1 and mas	ter control start processing is performed. After	
	setting the communication-i	n-process flag to 1, a start condition is generated	
	and a slave address is trans	smitted.	
Arguments	unsigned char addr	0x00 to 0x7F: Slave address	
	unsigned char rw	0x00: Master transmit	
		0x01: Master receive	
	unsigned char far *buf	Transmit/receive buffer pointer	
	unsigned char len	0x01 to 0xFF: Transmit data length	
Returned Value	unsigned char	0: Bus is busy	
		1: Bus is free	
		0xFF: Parameter error	

_ssuic	
Outline	I ² C bus interface interrupt processing
Header	None
Declaration	void _ssuic(void)
Description	An interrupt is generated at the rising edge of the ninth bit of the SCL clock or when a stop condition is detected. When a stop condition is detected, call the stp_int function. When a stop condition is not detected, call the master_trn_int function for master transmit and call the master_rcv_int function for master receive. To complete communication, generate a stop condition and enable the stop condition detection interrupt request.
Arguments	None
Returned Value	None



	• •
stp	Int

Outline	Stop condition detection processing
Header	None
Declaration	static void stp_int(void)
Description	This function is called from I ² C bus interface interrupt processing. The I ² C bus interface associated SFRs changed during communication are reset, and the communication-in-progress flag is set to 0.
Arguments	None
Returned Value	None

master_trn_int			
Outline	Master transmission		
Header	None		
Declaration	static unsigned char master_trn_int(void)		
Description	This function is called from the I ² C bus interface interrupt processing.		
	IIC_SP_OFF is returned in the following case:		
	 ACK is detected and not the last byte (starts next transmission). 		
	IIC_SP_ON is returned in the following case:		
	 NACK is detected (NACK detection error flag is set to 1). 		
	The last byte transmission is completed.		
Arguments	None		
Returned Value	unsigned char	IIC_SP_ON(0) : Stop condition generated	
		<pre>IIC_SP_OFF(1) : Stop condition not generated</pre>	

master_rcv_int				
Outline	Master reception			
Header	None			
Declaration	static unsigned char master_rcv_int(void)			
Description	This function is called from I ² C bus interface interrupt processing.			
	After transmitting the first byte (slave address), set to master receive mode and			
	enable the receive data full interrupt request.			
	IIC_SP_OFF is returned in the following case:			
	The following data is not the last byte of data.			
	IIC_SP_ON is returned in the following case:			
	 NACK is detected (NACK detection error flag is set to 1). 			
	The last byte has been received.			
Arguments	None			
Returned Value	unsigned char	IIC_SP_ON(0) : Stop condition generated		
		IIC_SP_OFF(1) : Stop condition not generated		



iic_master_end			
Outline	Master control end processing		
Header	None		
Declaration	unsigned char iic_mas	ter_end(void)	
Description	This function is called the state. During communic completed, this function needed.	from the main function. It informs the user of the master control cation, this function returns 0. When communication is n returns 1. Add processing for communication completion as	
Arguments	None		
Returned Value	unsigned char	0: Communication in progress	
		1: Communication completed	



3.7 Flowcharts

3.7.1 Main Processing

Figure 3.7 shows the Main Processing.



Figure 3.7 Main Processing



3.7.2 System Clock Setting

Figure 3.8 shows the System Clock Setting.



Figure 3.8 System Clock Setting



3.7.3 I²C_0 Initial Setting

Figure 3.9 and Figure 3.10 show the I^2C_0 Initial Setting.



Figure 3.9 I²C_0 Initial Setting (1/2)



1	2
Set the SICR1 0 register	Set I ² C 0 to standby mode
SICR1_0 register ← 88h Bits CKS3 to CKS0 = 1000b : Transfer clock f1/56 selected. TRS bit = 0 : Receive mode MST bit = 0 : Slave mode RCVD bit = 0 : After tHe SIRDR_0 register is read Whil is 0, next receive operation is continued	MSTCR1 register MSTIIC_0 bit ← 1: IICSSU_0 standby le TRS
Initialize the SICR2_0 register	
SICR2_0 register ← F5h	
Set the SIMR1_0 register	
SIMR1_0 register ← 10h Bits BC2 to BC0 = 000b : Bit counters set to 9 bits. CPOS_WAIT bit = 0 : No wait states (data and the a bit are transferred consecutive MLS bit = 0 : Set to 0 in I ² C bus interface m	ncknowledge ely) ode.
Set the IICCR_0 register	
IICCR_0 register ← 0Fh IICTCTWI bit = 0 : Transfer rate is the same as th with bits CKS3 to CKS0 in the IICTCHALF bit = 0 : Transfer rate is the same as th with bits CKS3 to CKS0 in the Bits SDADLY1 and SDADLY0 = 0 : Digital delay of 3 × f1 cycles	he value set 9 SICR1 register. he value set 9 SICR1 register.
SISR_0 register setting	
SISR register ← SISR register & 97h STOP bit = 0 : STOP bit cleared RDRF bit = 0 : RDRF bit cleared TEND bit = 0 : TEND bit cleared	
SIMR2_0 register setting	
SIMR2_0 register ← 00h MS bit = 0 : I ² C bus interface mode Bits SVA6 to SVA0 = 0 : Slave address set to 00h	
return	

Figure 3.10 I²C_0 Initial Setting (2/2)



3.7.4 Master Control Start Processing

Figure 3.11 and Figure 3.12 show the Master Control Start Processing.



Figure 3.11 Master Control Start Processing (1/2)





Figure 3.12 Master Control Start Processing (2/2)



3.7.5 I²C bus Interface Interrupt Processing

Figure 3.13 shows the I²C bus Interface Interrupt Processing.



Figure 3.13 I²C bus Interface Interrupt Processing



3.7.6 Stop Condition Detection

Figure 3.14 shows the Stop Condition Detection.



Figure 3.14 Stop Condition Detection



3.7.7 Master Transmission

Figure 3.15 shows the Master Transmission.



Figure 3.15 Master Transmission



3.7.8 Master Reception

Figure 3.16 shows the Master Reception.



Figure 3.16 Master Reception



3.7.9 Master Control End Processing

Figure 3.17 shows the Master Control End Processing.



Figure 3.17 Master Control End Processing



4. Sample Code

Sample code can be downloaded from the Renesas Electronics website.

5. Reference Documents

User's Manual: Hardware R8C/56E Group User's Manual: Hardware Rev.2.00 The latest version can be downloaded from the Renesas Electronics website.

Technical Update/Technical News

The latest information can be downloaded from the Renesas Electronics website.

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REVISION HISTORY

R8C/56E Group Application Note I²C bus Single Master Control Program (Master Transmit/Receive)

Rev.	Date	Description		
		Page	Summary	
1.00	Nov 30, 2012	—	First edition issued	

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- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
- 2. Processing at Power-on

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- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
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After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

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